



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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**Pb-free
HEAT**

STANLEY

1112H Series

Single Color High Brightness Type

Features

Package	2125(h =0.8mm) Type, Milky White resin
Product features	<ul style="list-style-type: none"> • Outer Dimension 2.0 x 1.25 x 0.8mm (L x W x H) • Temperature range Storage Temperature : -40°C~100°C Operating Temperature : -40°C~85°C • Lead-free soldering compatible • RoHS compliant
Dominant wavelength	Green : 562nm(YBG) Yellow Green : 572nm(YPY) Yellow : 590nm(FY) Orange : 605nm(FA) Red : 626nm(FR)
Half Intensity Angle	YBG : $\theta_x = 140 \text{ deg.}, \theta_y = 150 \text{ deg.}$ YPY : $\theta_x = 151 \text{ deg.}, \theta_y = 156 \text{ deg.}$ FY,FA,FR : $\theta_x = 148 \text{ deg.}, \theta_y = 145 \text{ deg.}$
Die materials	YBG,YPY,FY,FA,FR : AlGaInP
Rank grouping parameter	Sorted by luminous intensity and wavelength per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering and manual soldering
Taping and reel	4,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: ϕ 180mm
ESD	AlGaInP : More than 2kV(HBM)

Recommended Applications

Communication Machine, Electric Household Appliances, OA/FA, Other General Applications

Color and Luminous Intensity

(Ta=25°C)

Part No.	Material	Emitted Color	Lens Color	Dominant Wavelength		Luminous Intensity		
				λ_d (nm)		I _v (mcd)		
				TYP.	I _F	MIN.	TYP.	I _F
YBG1112H	AlGaInP	Green	Milky White	562	20	4.3	12	20
YPY1112H	AlGaInP	Yellow Green		572	20	19.8	35	20
FY1112H	AlGaInP	Yellow		590	20	25	65	20
FA1112H	AlGaInP	Orange		605	20	25	65	20
FR1112H	AlGaInP	Red		626	20	25	50	20

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings					Unit
		YBG	YPY	FY	FA	FR	
Power Dissipation	P_d	78	62.5	81	81	81	mW
Forward Current	I_F	30	25	30	30	30	mA
Pulse Forward Current ※1	I_{FRM}	100	60	100	100	100	mA
Derating (Ta=25°C or higher)	ΔI_F	0.43	0.36	0.43	0.43	0.43	mA/°C
	ΔI_{FRM}	1	0.86	1	1	1	mA/°C
Reverse Voltage	V_R	5	5	5	5	5	V
Operating Temperature	T_{opr}	-40~+85					°C
Storage Temperature	T_{stg}	-40~+100					°C

※1 I_{FRM} Measurement condition : $t_w \leq 1ms.$, Duty $\leq 1/20.$ (FY,FA,FR : Duty $\leq 1/10$)

Electro-Optical Characteristics (YBG, YPY, FY, FA, FR)

(Ta=25°C)

Item	Conditions	Symbol	Characteristics					Unit	
			YBG	YPY	FY	FA	FR		
Forward Voltage	I _F =20mA	V _F	TYP.	2.1	2.1	1.9	1.9	1.9	V
			MAX.	2.5	2.5	2.4	2.4	2.4	
Reverse Current	V _R =5V	I _R	MAX.	100	100	100	100	100	μ A
Peak Wavelength	I _F =20mA	λ _p	TYP.	565	575	592	609	635	nm
Dominant Wavelength	I _F =20mA	λ _d	TYP.	562	572	590	605	626	nm
Spectral Line Half Width	I _F =20mA	Δλ	TYP.	15	15	15	15	15	nm
Half Intensity Angle	I _F =20mA	2θ 1/2	TYP.	140(θ x)	151(θ x)	148(θ x)	148(θ x)	148(θ x)	deg.
				150(θ y)	156(θ y)	145(θ y)	145(θ y)	145(θ y)	

Luminous Intensity Rank

(Ta=25°C)

Rank	I _v (mcd)									
	YBG		YPY		FY		FA		FR	
	I _F =20mA		I _F =20mA		I _F =20mA		I _F =20mA		I _F =20mA	
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
A	4.3	8.5	19.8	28.0	25	50	25	50	25	50
B	6.0	12.0	23.3	33.0	35	70	35	70	35	70
C	8.5	17.0	28.0	40.0	50	100	50	100	50	100
D	12.0	24.0	33.0	46.7	70	140	70	140	70	140
E	17.0	34.0	40.0	56.6	100	200	100	200	100	200
F	24.0	-	46.7	-	140	-	140	-	140	-

※ Please contact our sales staff concerning rank designation.

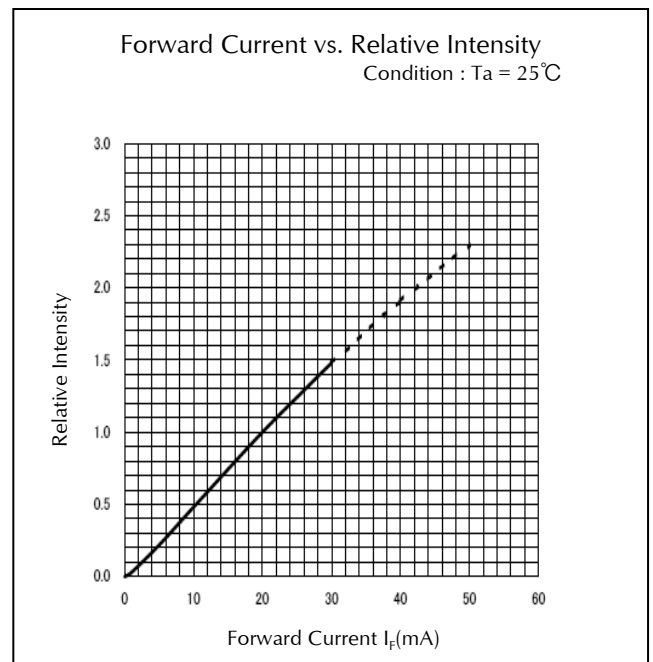
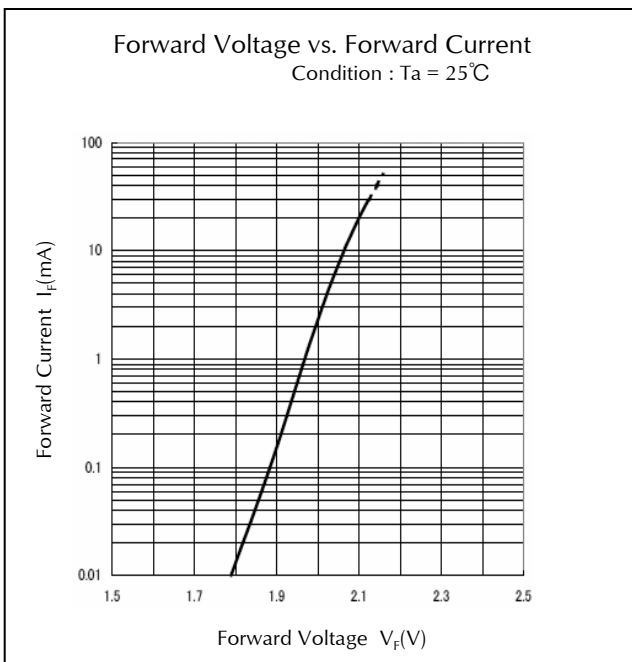
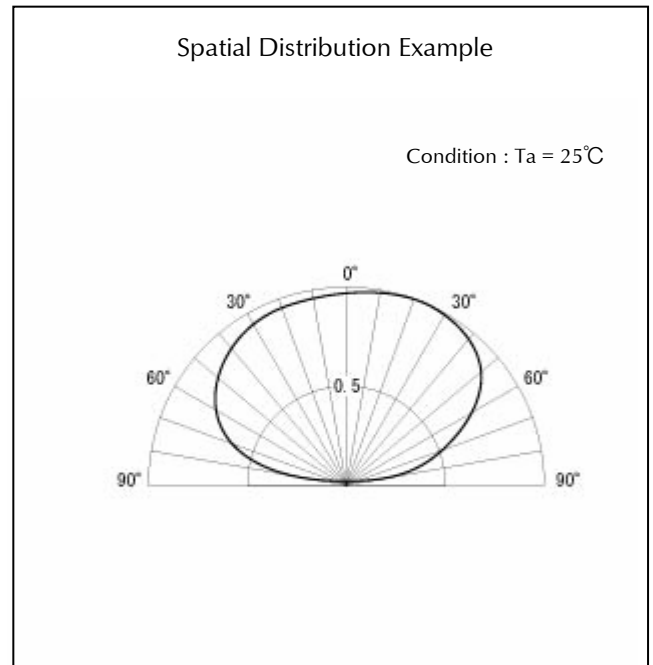
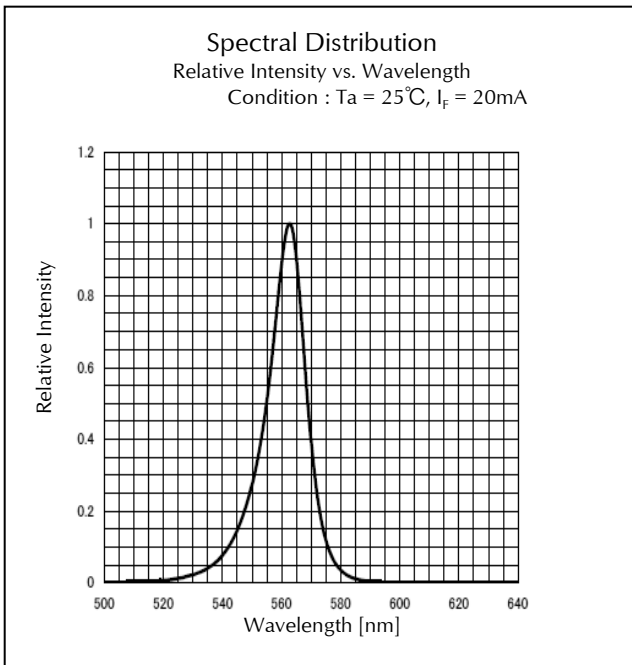
Color Tone Groups (λd)

(Ta=25°C)

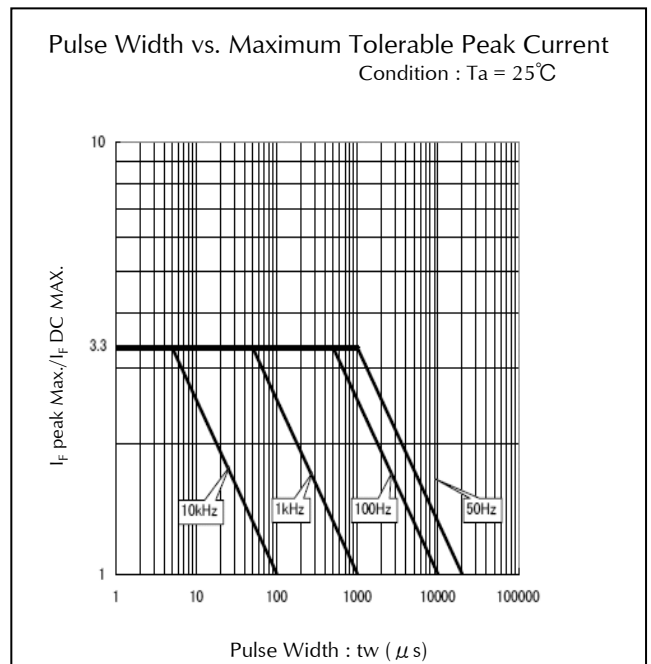
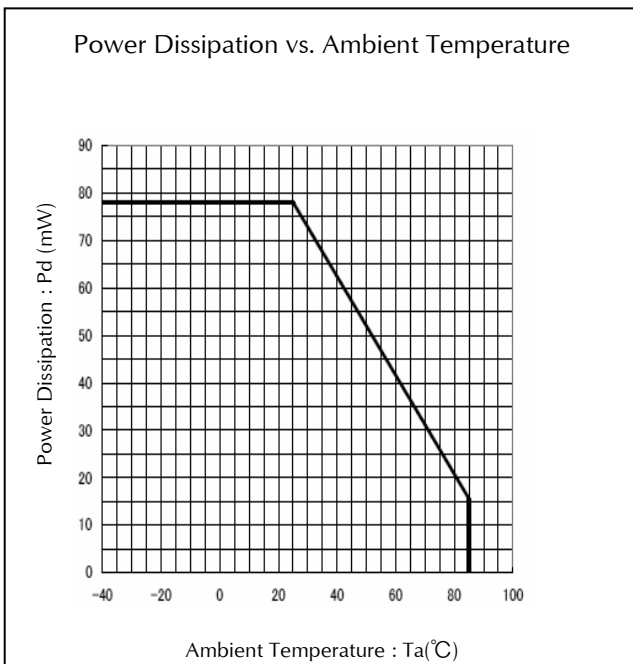
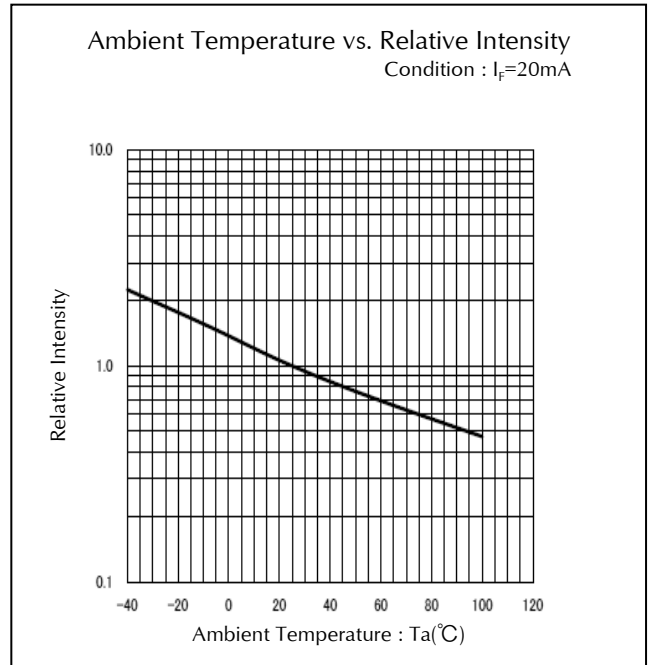
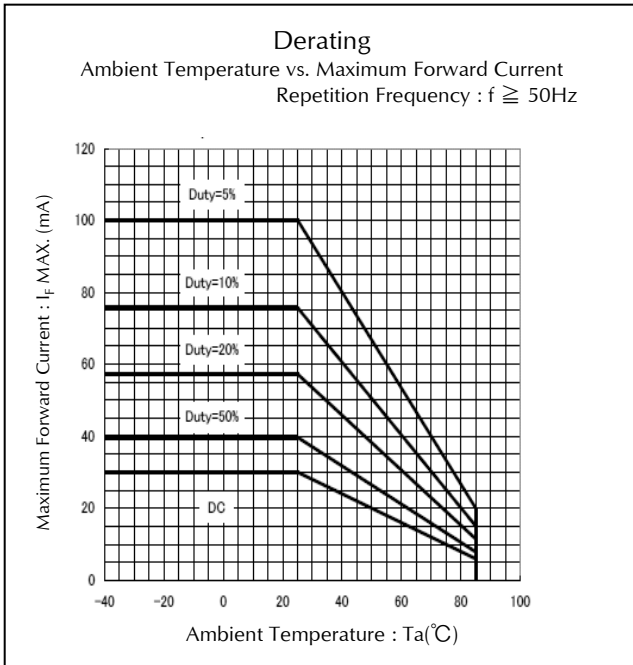
Rank	Dominant Wavelength λd (nm)					
	FY		FA		FR	
	I _F =20mA		I _F =20mA		I _F =20mA	
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
A	581.5	585.0	596.1	600.9	621.0	632.0
B	584.0	587.5	599.1	603.9	/	
C	586.5	590.0	602.1	606.9		
D	589.0	592.5	605.1	609.9		
E	591.5	595.0	608.1	612.9		
F	594.0	597.5				

※ Please contact our sales staff concerning rank designation.

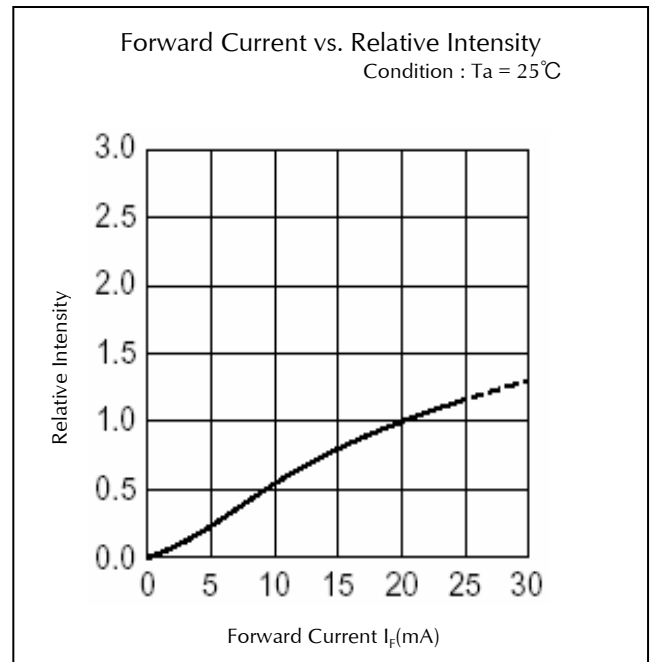
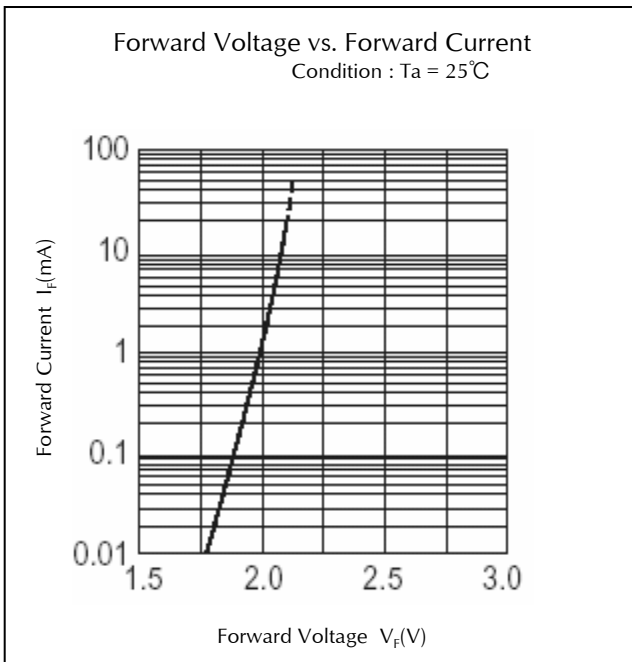
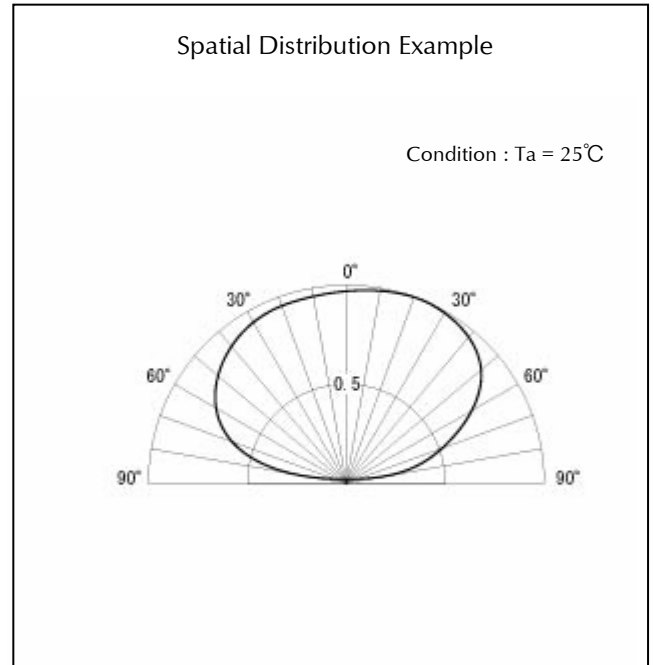
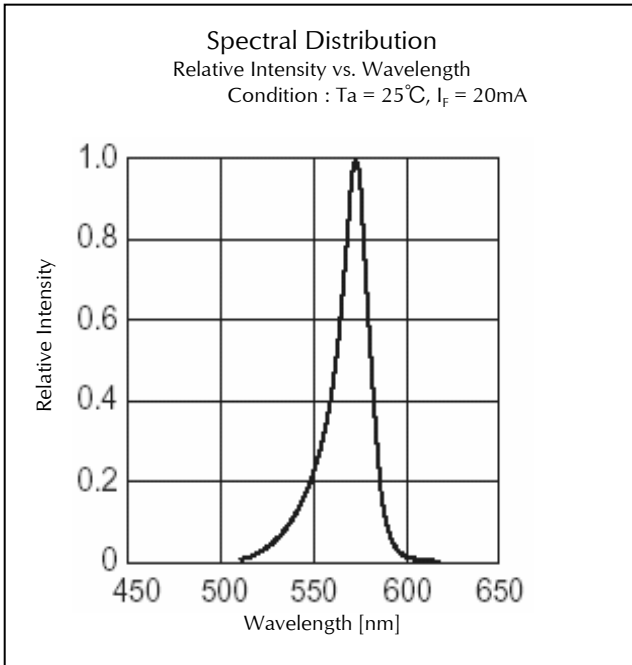
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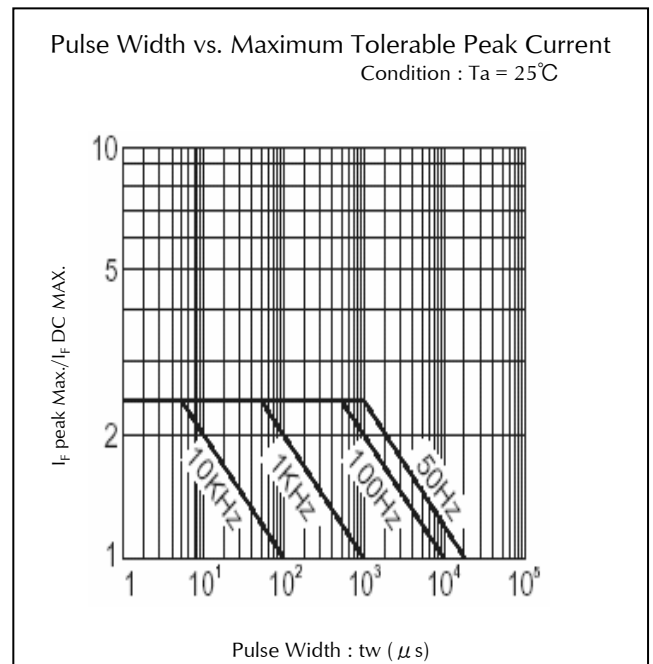
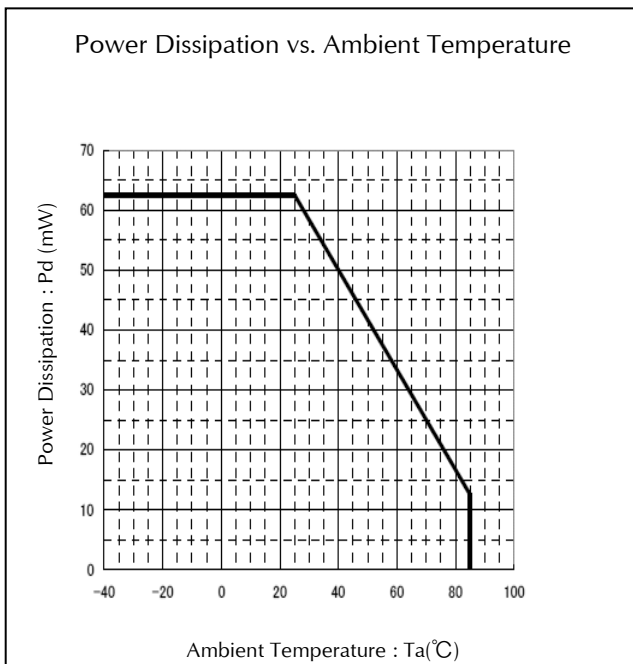
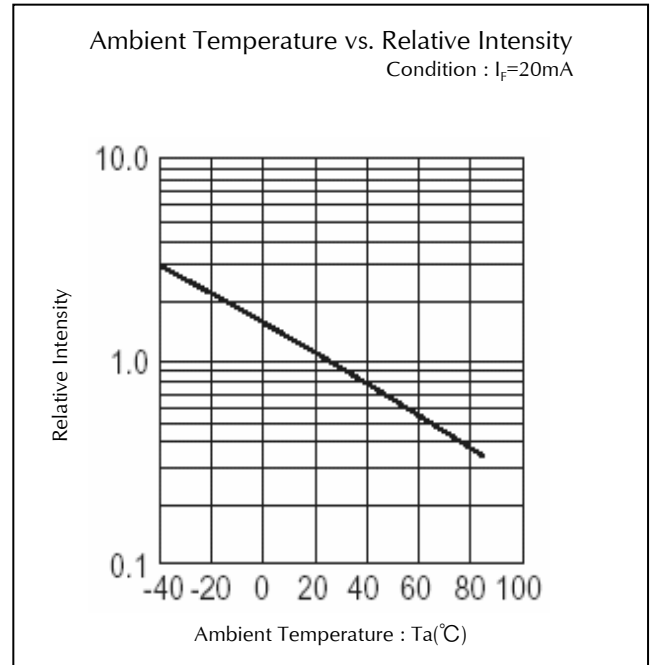
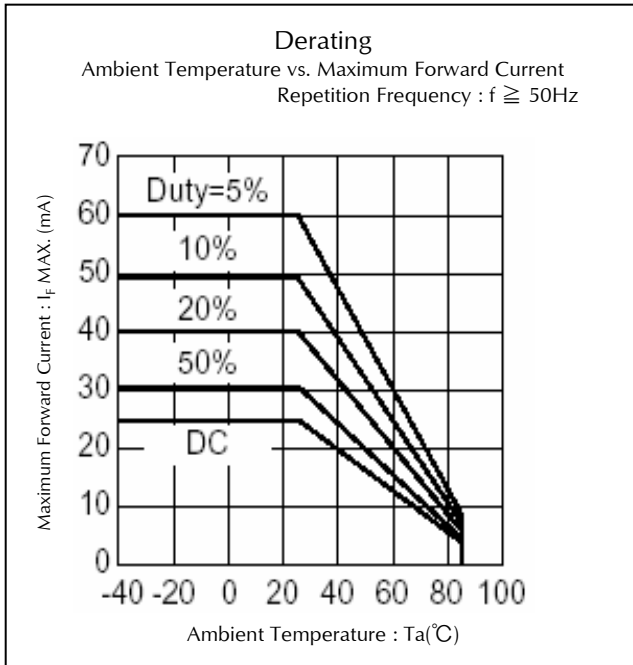
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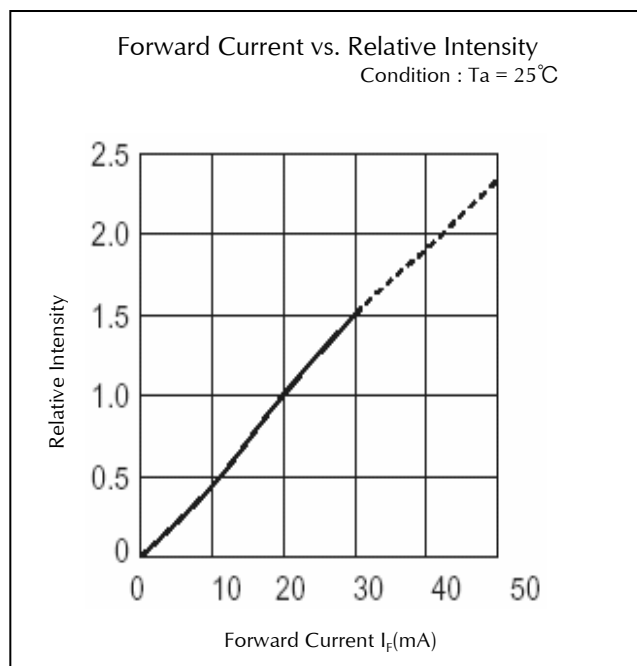
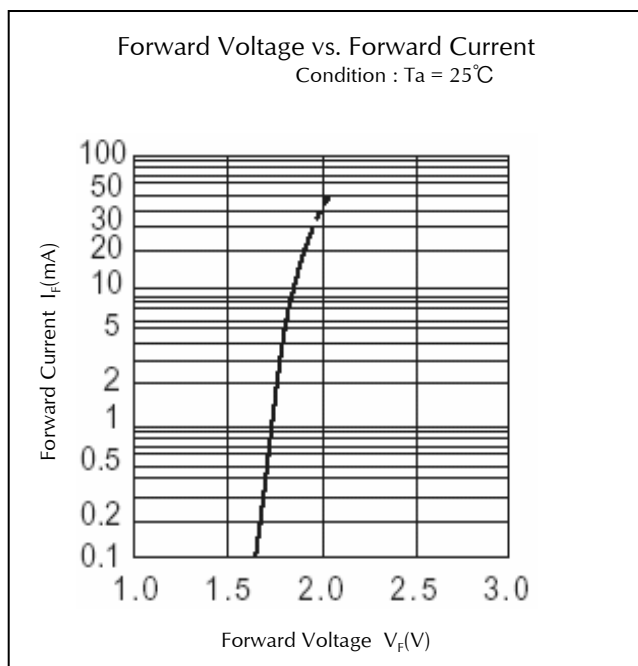
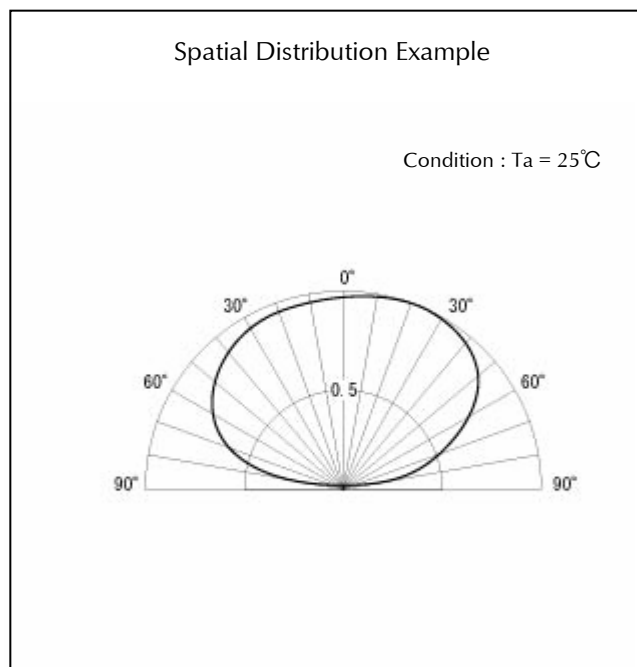
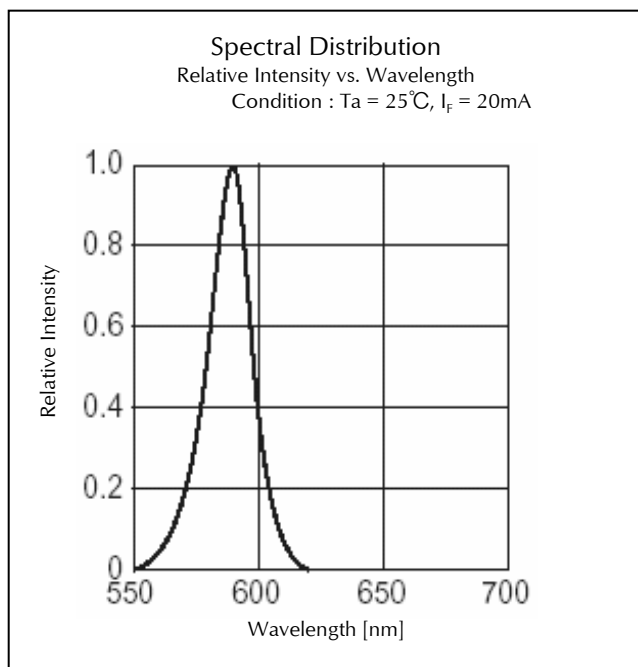
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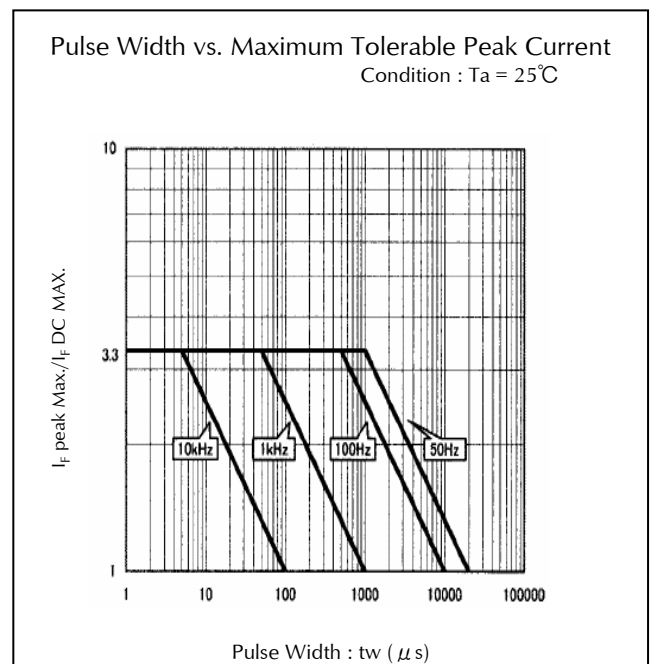
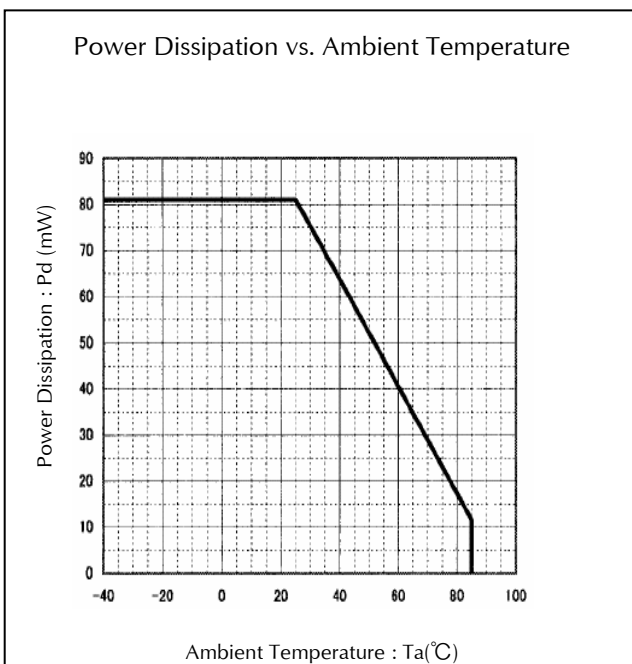
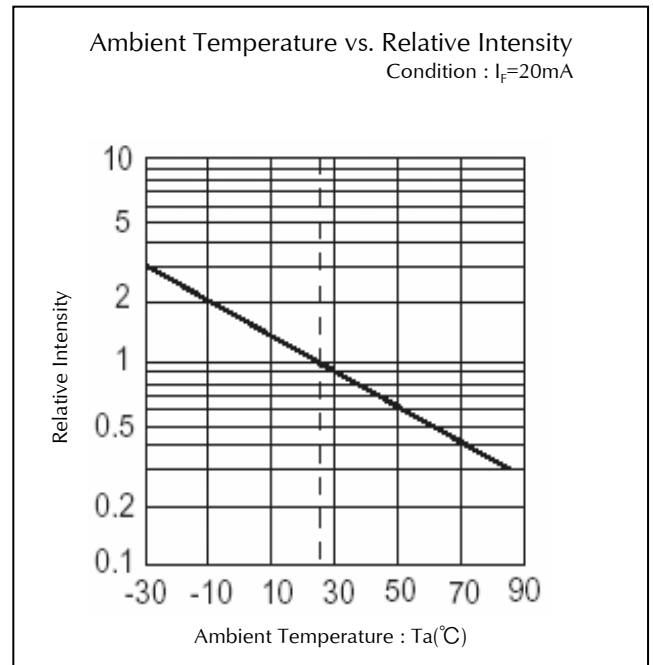
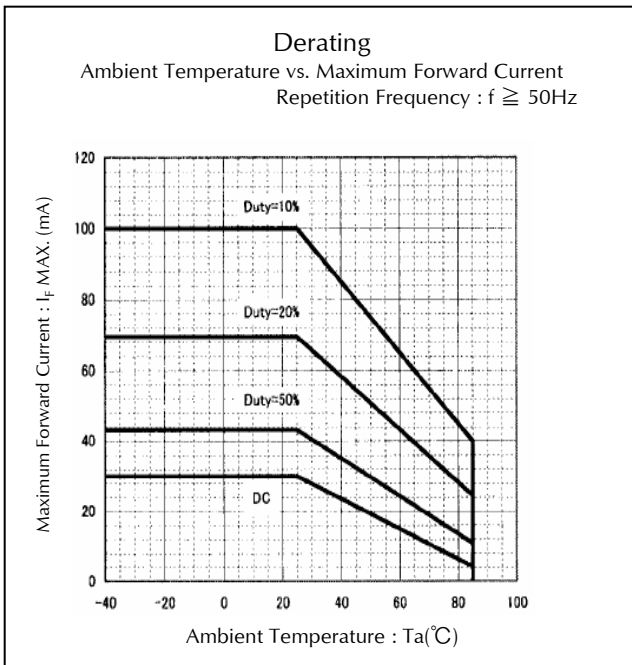
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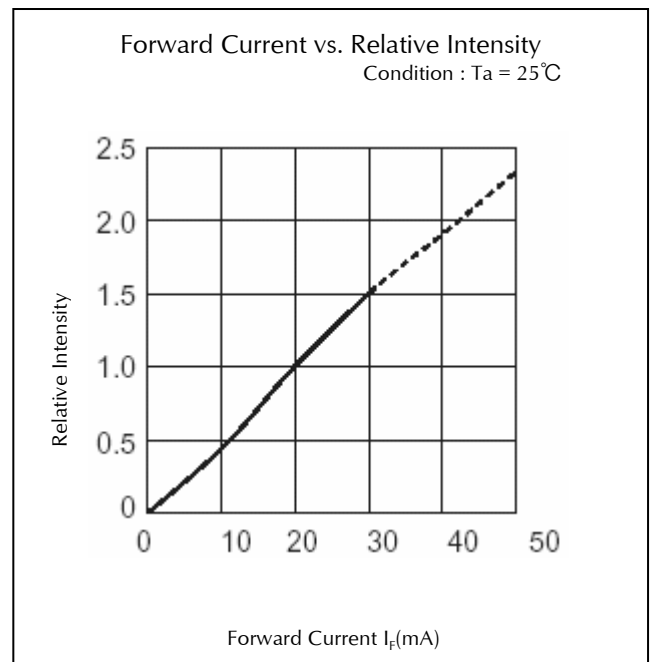
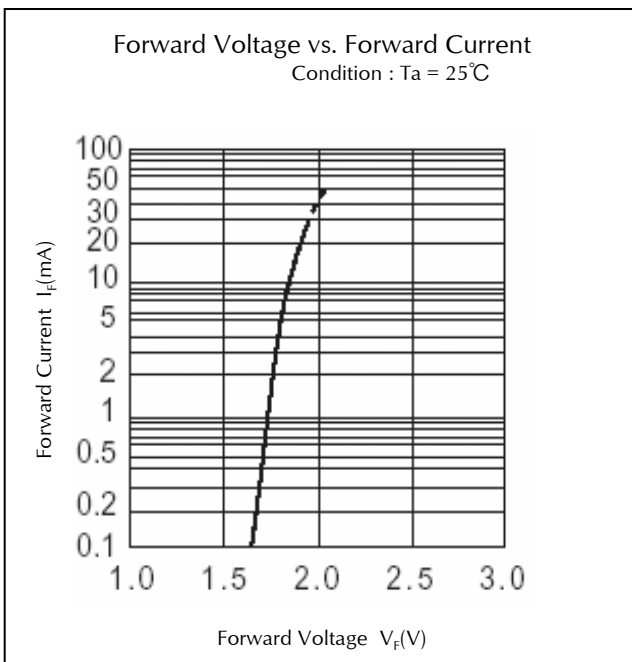
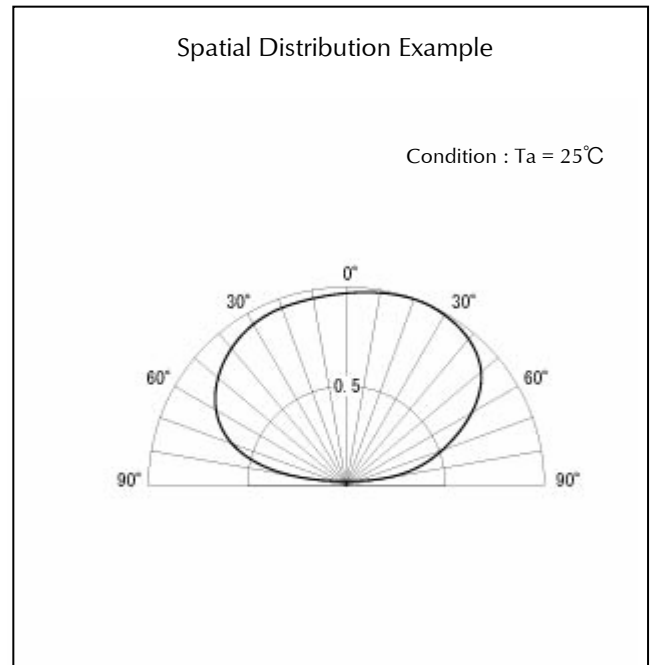
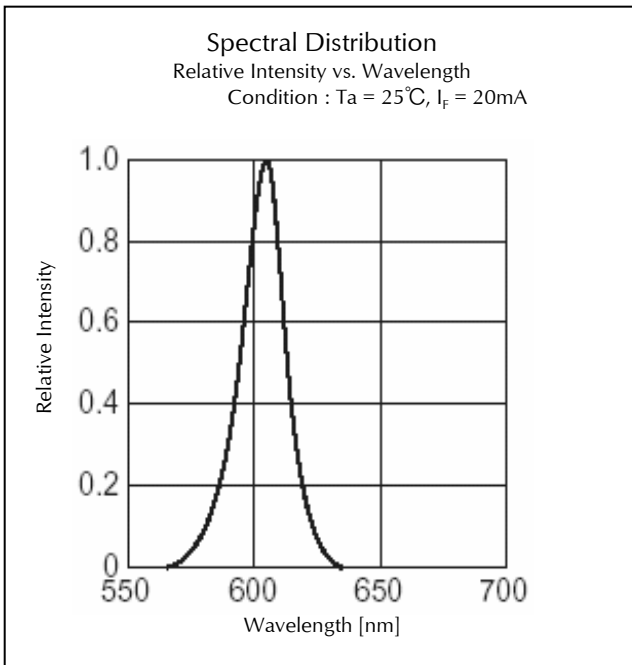
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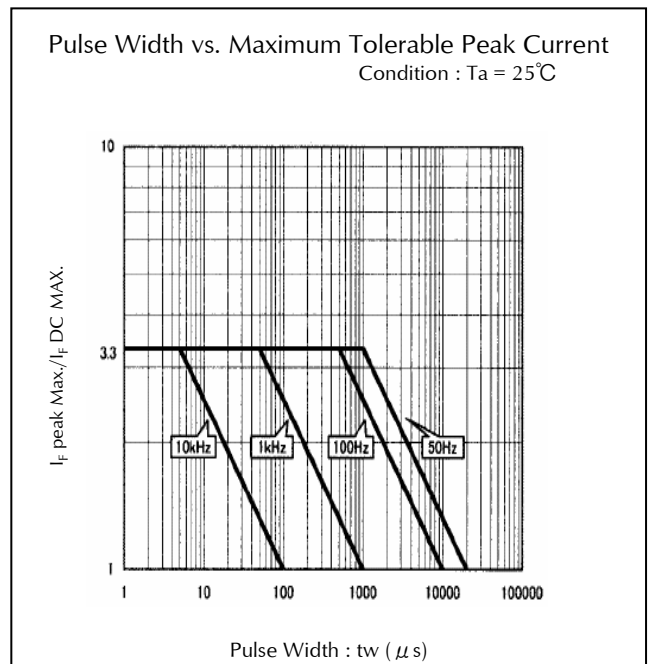
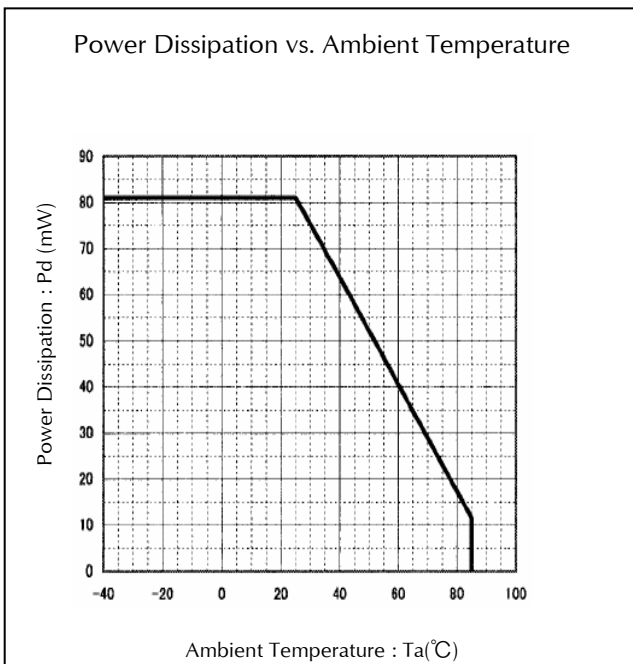
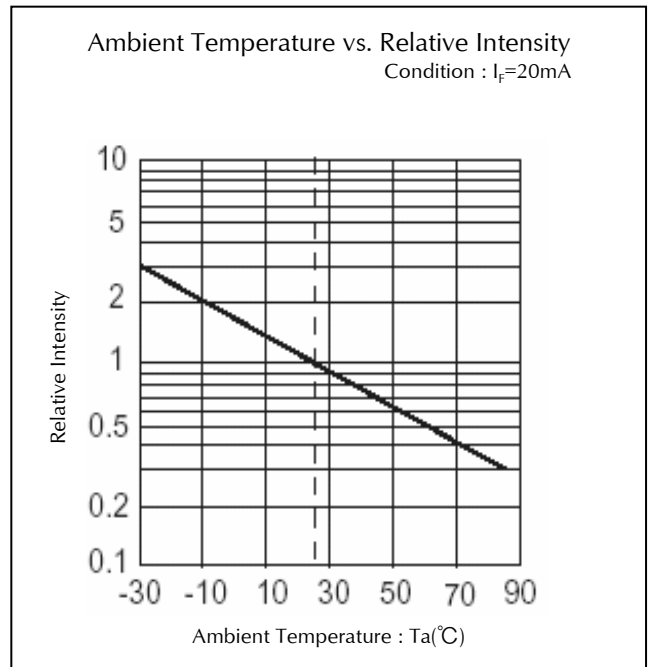
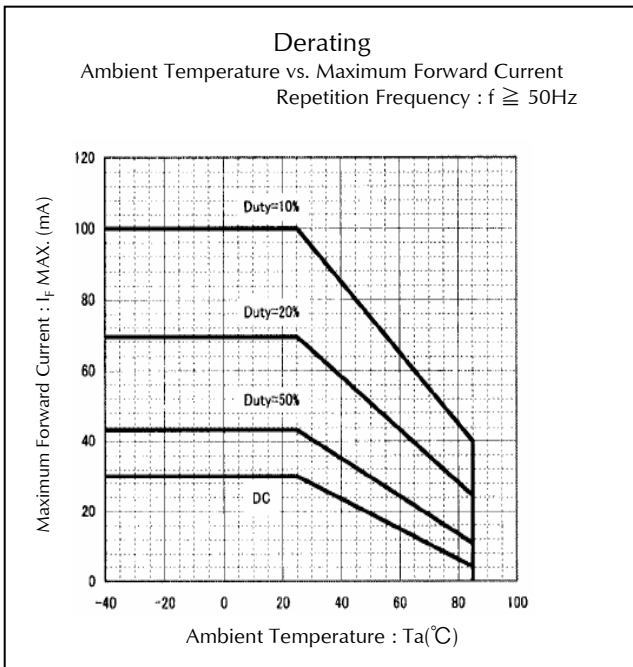
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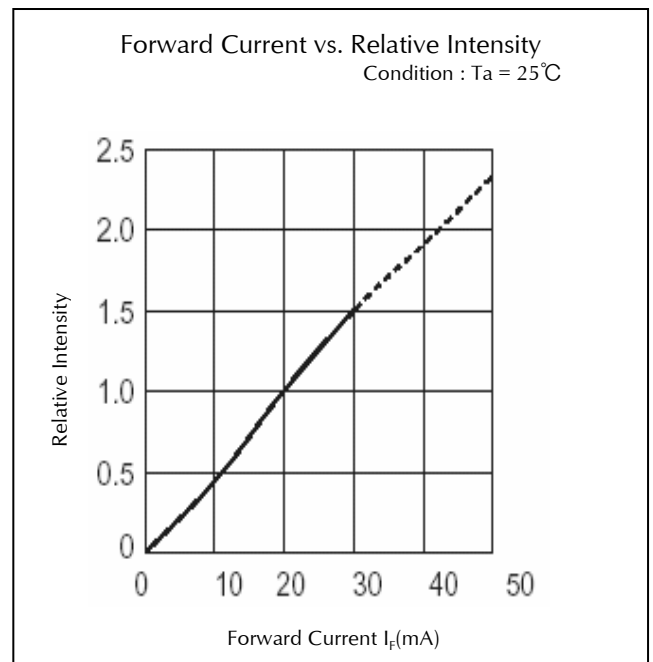
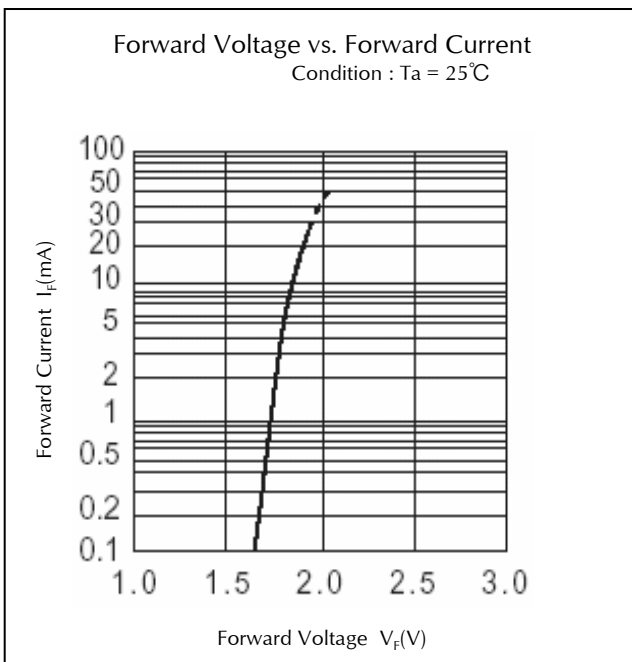
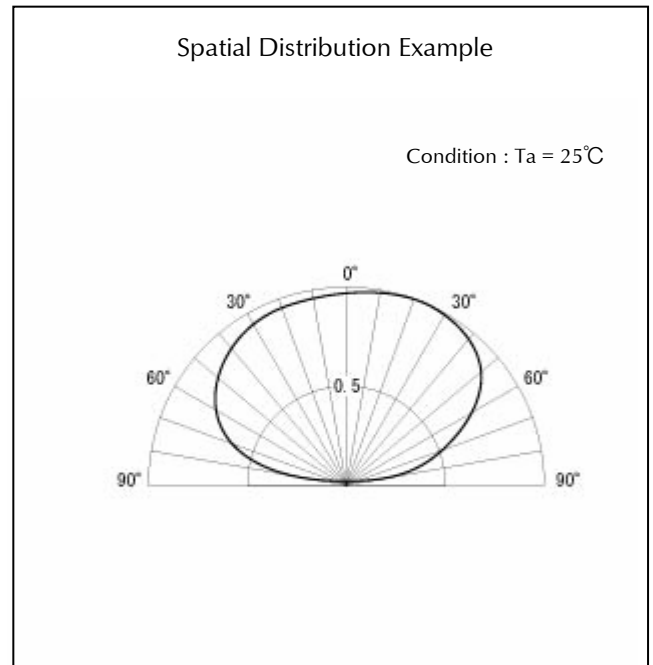
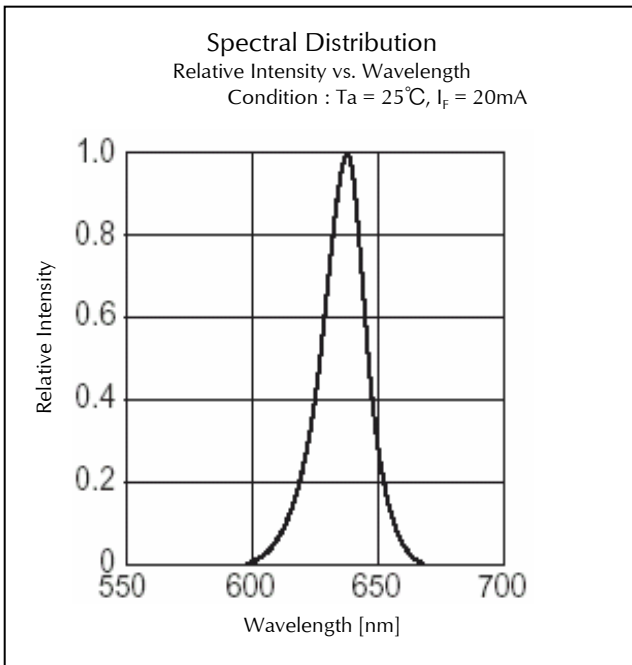
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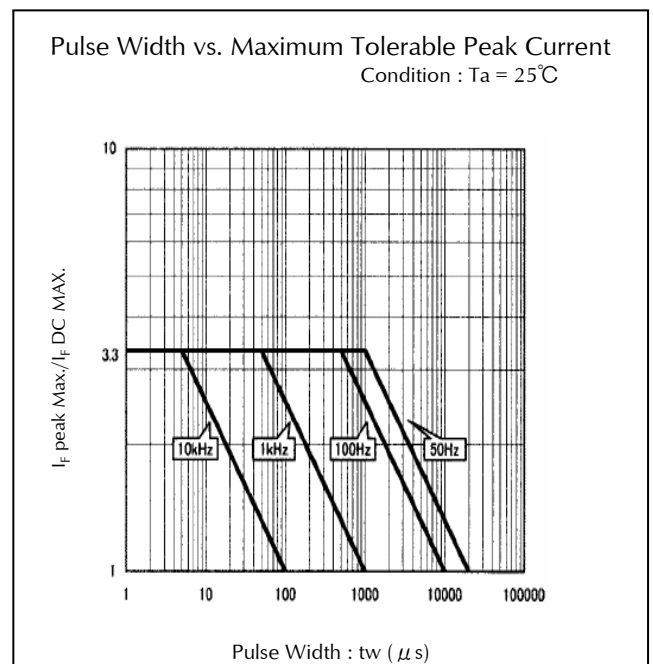
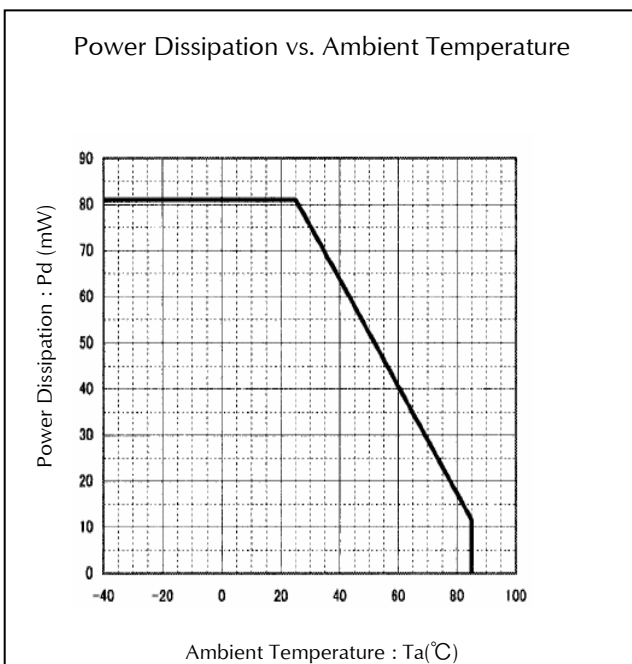
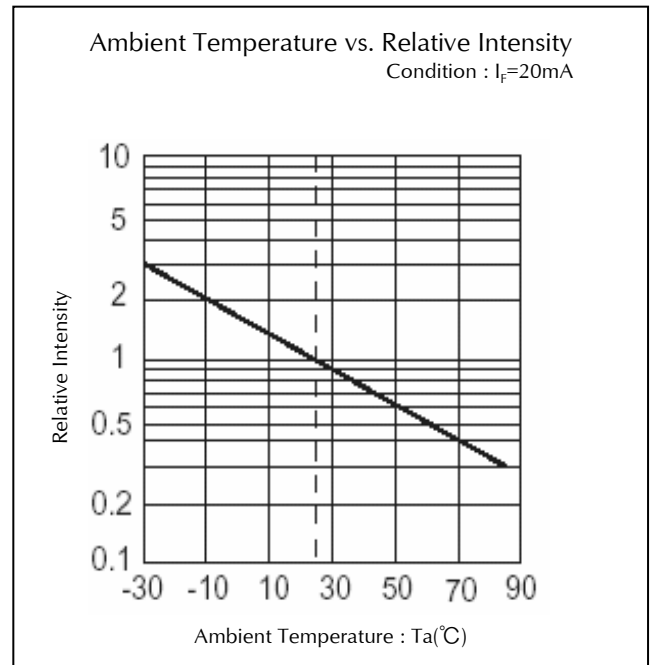
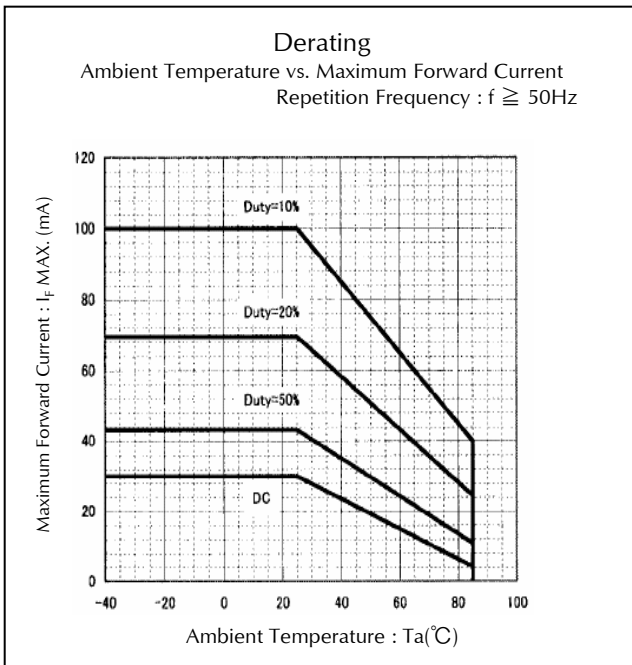
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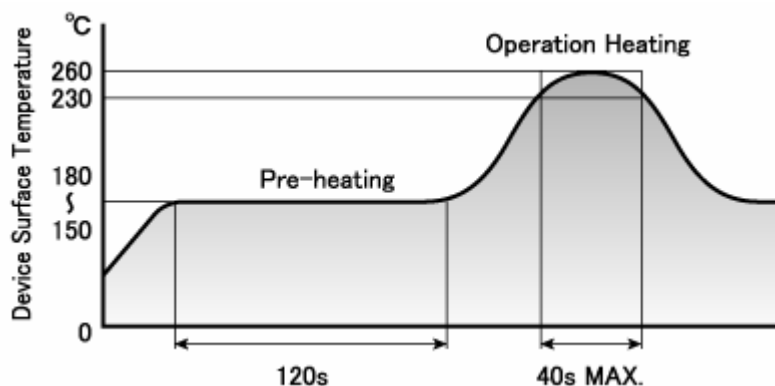
Technical Data(FR)



Technical Data(FR)



Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized.

Manual Soldering Conditions

Iron tip temp.	350 °C	(MAX.)
Soldering time and frequency	3 s	(MAX.)
	1 time	(MAX.)

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(301)	Pre-heating : 150~180°C 120s Max. Operation Heating : 230°C 40s Max. Peak Temperature : 260°C	Twice	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	Vf	If Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	Ir	Vr = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking

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